C2000 Digital Signal Processor
TMS320F2802x

12V

INA181A2

LM5101B

CSD17573

TLV70433

CSD17573

CSD17573

LM5101B

LMT88

50Hz Transformer

AC 120V/220V

Temp Sense

AC Vsense

AC Isense

External card

Vd sense

IB_HS

3.3
PCB Number: TIDA-01292
PCB Rev: E1

Texas Instruments

PCB
LOGO

PCB
LOGO

PCB
LOGO

PCB
LOGO

PCB
LOGO

Variant/Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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</thead>
<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
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<tr>
<td>002</td>
<td>ChangeMe!</td>
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</table>

**Assembly Note**: This Assembly Note is for PCB labels only.

**Assembly Note**: These assemblies are ESD sensitive. ESD precautions shall be observed.

**Assembly Note**: These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.

**Assembly Note**: These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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